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Exhibit A



Search result: 1 of 1

(WO/2003/087230) THERMOSETTING RESIN COMPOSITION AND PREPREG AND LAMINATED SHEET USING THE SAME

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Title: THERMOSETTING RESIN COMPOSITION AND PREPREG AND LAMINATED SHEET USING THE SAME

Abstract: A thermosetting resin composition, characterized in that it comprises (1) a metal salt of a di-substituted phosphinic acid and (2) a resin exhibiting a relative dielectric constant at a frequency of 1 GHz or more of 2.9 or less; and a prepreg and a laminated sheet using the resin composition.

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